

LEAD FREE SERIES - HEATED GLASS COMPOSITIONS

PRODUCT DESCRIPTION

DuPont™ 399X Series Defogger Silver conductor compositions are provided for use in production of electrically heated glass. The 399X series will provide excellent printability and high print definition. Series members can be blended with each other to obtain a wide range of electrical resistance. These compositions have been designed to provide a robust fired layer that is resistant to environmental and chemical influences.

PRODUCT BENEFITS

- Low laydown
- Wide range of electrical resistance
- Enhanced Green Strength
- Wide process window when co-firing over enamels
- Lead-Free* and Cadmium-Free*
- Robust printing performance
- Supplied ready to print

*Cadmium and lead "free" as used herein means that these are not intentionally added to the referenced product. Trace amounts however may be present.

PROCESSING

Blending

In order to obtain a specific resistance value, the pastes can be blended with each other. A computer program or semi logarithmic graphs can be used to determine blend recipes for specific heated window designs.

Drying

Allow printed paste to dry to desired green strength at between 125–150°C, if drying is needed.

TYPICAL

Printing Parameters					
Screen mesh size (per inch)*	150 – 280				
Emulsion thickness (µm)	12 - 25				
Emulsion type	Terpene resistant				
Enamel compatibility	Air Dried and some UV				
Firing					
Average Glass Surface Temp. (°C)	600 - 670 over enamel 600 - 700 over glass				
Furnace atmosphere	sulphite free				
Soldering					
Burnish	Steel Wool or Fiberglass				
Flux	Type R - rosin				
Connector	Copper Clip or Braid pref. pre-tinned				

^{*}stainless steel screens are used in laboratory testing

TABLE 1: COMPOSITION PROPERTIES

Test	Properties				
	3991	3992	3993		
Silver Content (%)	78.8	61.5	59.6		
Total Solids (%)	82.0 - 84.0	64.5 – 66.5	64.0 – 66.0		
Viscosity (Pa·S) [Brookfield RVT #14 @ 10 rpm]	25 – 40				
Thinner	DuPont 9450				

TABLE 2: TYPICAL PHYSICAL PROPERTIES

Test	Properties				
	3991	3992	3993		
Resistivity Typical (Ω/ft) Typical (mΩ/sq) @ 8 μm Rel. Range (± %)	0.7 3.1 20	1.7 3.4 20	2.7 10.3 20		
Fired Thickness (µm) Range Typical	10.0 – 14.0	8.0 – 12.0	8.0 – 10.0		
Line Width (µm) Range	350 – 800				
Color Air side color Tin side color	Light Brown/Yellow Dark Brown				
Solder metallurgy	Pb and Pb-free				
Adhesion (kg force) Pb containing Clips Pb-free Clips	40 55	25 58	32 56		

Test procedures

Printing: 200 mesh stainless steel screen, 12µm emulsion

Firing: 30 minute cycle, 11 zone belt furnace, peak temperature of 640°C

Adhesion Test: Soldered copper clip, 70Pb/27Sn/3Ag, and Pb-free (In content) reflowed with flame Substrate: 2"x4" soda lime silicate glass, 4 mm thick

Tables 1 and 2 show anticipated typical physical properties for DuPont 399X series based on specific controlled experiments in our labs and are not intended to represent the product specifications, details of which are available upon request.

399X PB-FREE BLEND DENSITIES AND RS

	Gardco WG- SS-83.2 Cup Wgt (g)	Gardco WG- SS-8.32 Cup Wgt (g)	Paste Density	Nominal R (Ω/ft)	Nominal R (mΩ/sq/8μm)	Nominal SR (μΩ-cm)
3991	323.0	32.3	3.88	0.72	3.12	2.50
90:10	310.3	31.0	3.73	0.82	3.15	2.52
80:20	297.5	29.8	3.58	0.92	3.18	2.55
70:30	284.8	28.5	3.42	1.02	3.21	2.57
60:40	272.0	27.2	3.27	1.12	3.25	2.60
50:50	259.3	25.9	3.12	1.22	3.28	2.62
40:60	246.6	24.7	2.96	1.32	3.31	2.65
30:70	233.8	23.4	2.81	1.41	3.34	2.67
20:80	221.1	22.1	2.66	1.51	3.37	2.70
10:90	208.4	20.8	2.50	1.61	3.40	2.72
3992	195.6	19.6	2.35	1.71	3.43	2.75
90:10	195.6	19.6	2.35	1.80	4.12	3.06
80:20	195.2	19.5	2.34	1.89	4.80	3.36
70:30	194.8	19.5	2.34	1.98	5.49	3.67
60:40	194.4	19.4	2.33	2.07	6.18	3.97
50:50	194.0	19.4	2.33	2.16	6.87	4.28
40:60	193.6	19.4	2.33	2.24	7.55	4.58
30:70	193.2	19.3	2.32	2.33	8.24	4.89
20:80	192.8	19.3	2.32	2.42	8.93	5.19
10:90	192.4	19.2	2.31	2.51	9.61	5.50
3993	192.0	19.2	2.31	2.60	10.30	5.80

Typical properties are based on laboratory tests, using the following conditions:

	Gardco WG- SS-83.2 Cup Wgt (g)	Gardco WG- SS-8.32 Cup Wgt (g)	Paste Density	Nominal R (Ω/ft)	Nominal R (mΩ/sq/8μm)	Nominal SR (μΩ-cm)
3991	323.0	32.3	3.88	0.72	3.10	2.50
90:10	309.9	31.0	3.72	0.91	3.82	2.83
80:20	296.8	29.7	3.57	1.10	4.54	3.16
70:30	283.7	28.4	3.41	1.28	5.26	3.49
60:40	270.6	27.1	3.25	1.47	5.98	3.82
50:50	257.5	25.8	3.10	1.66	6.70	4.15
40:60	244.4	24.4	2.94	1.85	7.42	4.48
30:70	231.3	23.1	2.78	2.04	8.14	4.81
20:80	218.2	21.8	2.62	2.22	8.86	5.14
10:90	205.1	20.5	2.47	2.41	9.58	5.47
3993	192.0	19.2	2.31	2.60	10.30	5.80

STORAGE AND SHELF LIFE

Containers should be stored, tightly sealed, in a clean, stable environment at room temperature (<25°C). Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

SAFETY AND HANDLING

For information on health and safety regulations please refer to the specific product MSDS.



FOR MORE INFORMATION ON 399X SERIES OR OTHER DUPONT ADVANCED MATERIALS, PLEASE CONTACT YOUR LOCAL REPRESENTATIVE:

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